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April 2008

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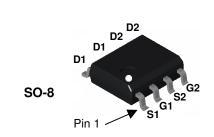
Dual N & P-Channel PowerTrench[®] MOSFET

General Description

These dual N- and P-Channel enhancement mode power field effect transistors are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state ressitance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.





Features

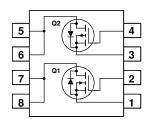
• Q1: N-Channel

7.0A, 30V $R_{DS(on)} = 0.028\Omega @ V_{GS} = 10V$ $R_{DS(on)} = 0.040\Omega @ V_{GS} = 4.5V$

Q2: P-Channel

-5A, -30V $R_{DS(on)} = 0.052\Omega @ V_{GS} = -10V$ $R_{DS(on)} = 0.080\Omega @ V_{GS} = -4.5V$

- Fast switching speed
- High power and handling capability in a widely used surface mount package



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

| Symbol | Parameter | | Q1 | Q2 | Q2 Units | | |
|------------------------------------------------|--------------------------------------------------|---------------------------------------------------------------------|----------------|-------------|----------|--------------|--|
| V _{DSS} | Drain-Sourc | e Voltage | | 30 | 30 | V | |
| V _{GSS} | Gate-Source | e Voltage | | ±20 ±20 | | V | |
| ID | Drain Curre | nt - Continuous | (Note 1a) | 7 | -5 | | |
| | | - Pulsed | | 20 | -20 | А | |
| P _D | Power Dissipation for Dual Operation | | | 2 | 2 | | |
| | Power Dissipation for Single Operation | | n (Note 1a) | 1.6 | 1.6 | W | |
| | | (Note 1c) | 0.9 | 0.9 | 7 | | |
| E _{AS} | Single Pulse | e Avalanche Energy | (Note 3) | 54 | 13 | mJ | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | perature Range | -55 to +150 | | °C | |
| Therma R _{θJA} R _{θJC} | | teristics sistance, Junction-to-Amb sistance, Junction-to-Cas | , , | 78 | | °C/W °C/W | |
| | e Markin | g and Ordering I | | Таре и | | Quantity | |
| FDS8958A | | FDS8958A | 13" | 12m | im | 2500 units | |

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| Symbol | Parameter | Test | Туре | Min | Тур | Мах | Units | |
|----------------------------------------|----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------|----------|-----------|----------------|----------------|-------|
| Off Cha | racteristics | | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | | I _D = -250 μA | Q1 Q2 | 30 -30 | | | V |
| <u>ΔBVdss</u> ΔTj | Breakdown Voltage Temperature Coefficient | $I_{D} = 250 \ \mu A, \ R$ | leferenced to 25°C | Q1 Q2 | | 25 -23 | | mV/°C |
| DSS | Zero Gate Voltage Drain Current | $V_{DS} = 24 V,$ $V_{DS} = -24 V,$ | Referenced to $25^{\circ}C$ $V_{GS} = 0 V$ $V_{GS} = 0 V$ | Q1 Q2 | | | 1 -1 | μA |
| GSSF | Gate-Body Leakage, Forward | $V_{DS} = -24 V,$ $V_{GS} = 20 V,$ | $V_{DS} = 0 V$ | All | | | 100 | nA |
| GSSR | Gate-Body Leakage, Reverse | $V_{GS} = -20 V$, | $V_{DS} = 0 V$ | All | | | -100 | nA |
| On Cha | racteristics (Note 2) | | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS},$ $V_{DS} = V_{GS},$ | I _D = 250 μA I _D = -250 μA | Q1 Q2 | 1 -1 | 1.9 -1.7 | 3 -3 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate Threshold Voltage | $I_D=250~\mu A,~Re$ | eferenced to 25°C eferenced to 25°C | Q1 Q2 | | -4.5 4.5 | | mV/°C |
| R _{DS(on)} | On-Resistance | $V_{GS} = 4.5 V$, | = 7 A, T _J = 125°C I _D = 6 A | Q1 | | 19 27 24 | 28 42 40 | mΩ |
| | | $V_{GS} = -10 V,$ $V_{GS} = -10 V, I_{D}$ | I _D = -5 A = -5 A, T _J = 125°C | Q2 | | 42 57 65 | 52 78 80 | |
| D(on) | On-State Drain Current | $\label{eq:VGS} \begin{split} &V_{GS} = -4.5 \ V, \\ &V_{GS} = 10 \ V, \\ &V_{GS} = -10 \ V, \\ &V_{DS} = 5 \ V, \end{split}$ | $V_{DS} = 5 V$ $V_{DS} = -5 V$ | Q1 Q2 | 20 -20 | | | A |
| g fs | | | | Q1 Q2 | | 25 10 | | S |
| Dynami | c Characteristics | | | | | | | |
| C _{iss} | | Q1 V _{DS} = 15 V, V _{GS} | = 0 V, f = 1.0 MHz | Q1 Q2 | | 575 528 | | pF |
| C _{oss} | Output Capacitance | Q2 | | Q1 Q2 | | 145 132 | | pF |
| C _{rss} | Reverse Transfer Capacitance | $V_{DS} = -15 V, V_{C}$ | _{as} = 0 V, f = 1.0 MHz | Q1 Q2 | | 65 70 | | pF |
| R _G | Gate Resistance | $V_{GS} = 15 \text{ mV},$ | f = 1.0 MHz | Q1 Q2 | | 2.1 6.0 | | Ω |

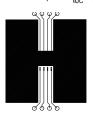
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FDS8958A Rev F3 (W)

| Electri | cal Characteristics | (continued) $T_A = 25 ^{\circ}\text{C}$ unless othe | rwise noted | I | | | |
|---------------------|------------------------------------------------------------|---------------------------------------------------------------------------------------|-------------|-----|---------------|-------------|-------|
| Symbol | Parameter | Test Conditions | Туре | Min | Тур | Max | Units |
| Switchi | ng Characteristics (Note | 2) | | | | | |
| t _{d(on)} | Turn-On Delay Time | Q1 V _{DD} = 15 V, I _D = 1 A, | Q1 Q2 | | 8 7 | 16 14 | ns |
| t _r | Turn-On Rise Time | V_{GS} = 10V, R_{GEN} = 6 Ω | Q1 Q2 | | 5 13 | 10 24 | ns |
| t _{d(off)} | Turn-Off Delay Time | Q2 V _{DD} = -15 V, I _D = -1 A, | Q1 Q2 | | 23 14 | 37 25 | ns |
| t _f | Turn-Off Fall Time | V_{GS} = -10V, R_{GEN} = 6 Ω | Q1 Q2 | | 3 9 | 6 17 | ns |
| Qg | Total Gate Charge | Q1 V _{DS} = 15 V, I _D = 7 A, V _{GS} = 10 V | Q1 Q2 | | 11.4 9.6 | 16 13 | nC |
| Q_{gs} | Gate-Source Charge | Q2 | Q1 Q2 | | 1.7 2.2 | | nC |
| Q _{gd} | Gate-Drain Charge | $V_{DS} = -15 \text{ V}, \text{ I}_{D} = -5 \text{ A}, \text{V}_{GS} = -10 \text{ V}$ | Q1 Q2 | | 2.1 1.7 | | nC |
| Drain-S | Source Diode Character | ristics and Maximum Rating | S | | | | |
| ls | Maximum Continuous Drain-Source Diode Forward Current | | | | | 1.3 -1.3 | A |
| I _{SM} | Maximum Plused Drain-Source Diode Forward Current (Note 2) | | | | | 20 -20 | A |
| V _{SD} | Drain-Source Diode Forward Voltage | | Q1 Q2 | | 0.75 -0.88 | 1.2 -1.2 | V |
| t _{rr} | Diode Reverse Recovery Time | Q1 I _F = 7 A, d _i /d _t = 100 A/μs | Q1 Q2 | | 19 19 | | nS |
| Q _{rr} | Diode Reverse Recovery Charge | Q2 Ι _F = -5 A, d _{iF} /d _t = 100 A/μs | Q1 Q2 | | 9 6 | | nC |

Notes:

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 78°/W when mounted on a 0.5 in² pad of 2 oz copper



b) 125°/W when mounted on a .02 in² pad of 2 oz copper

c) 135 °/W when mounted on a minimum pad.

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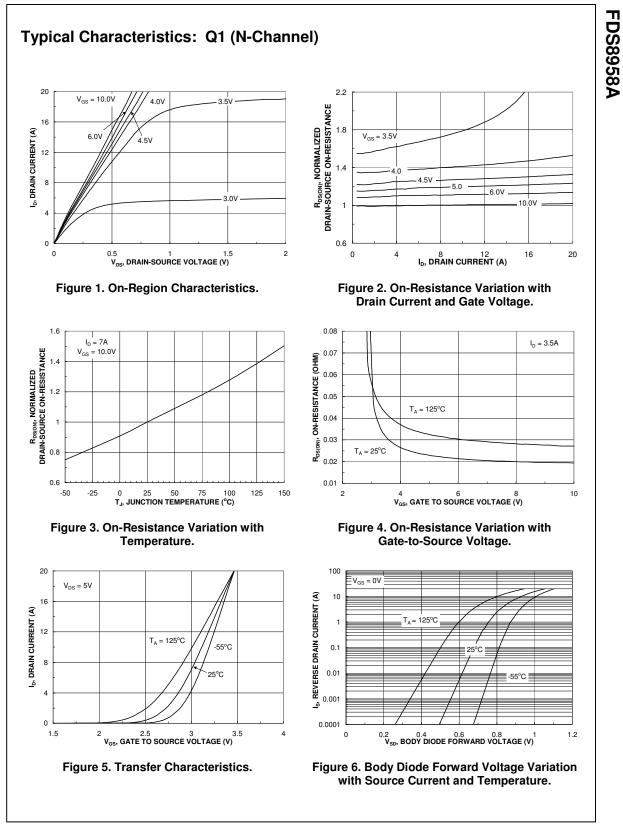
FDS8958A

Scale 1 : 1 on letter size paper

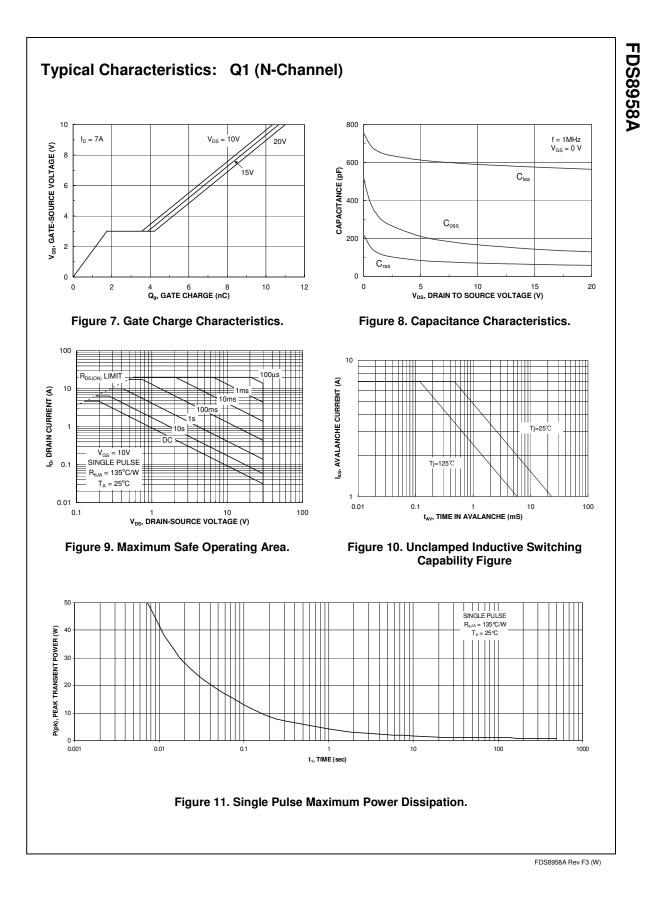
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

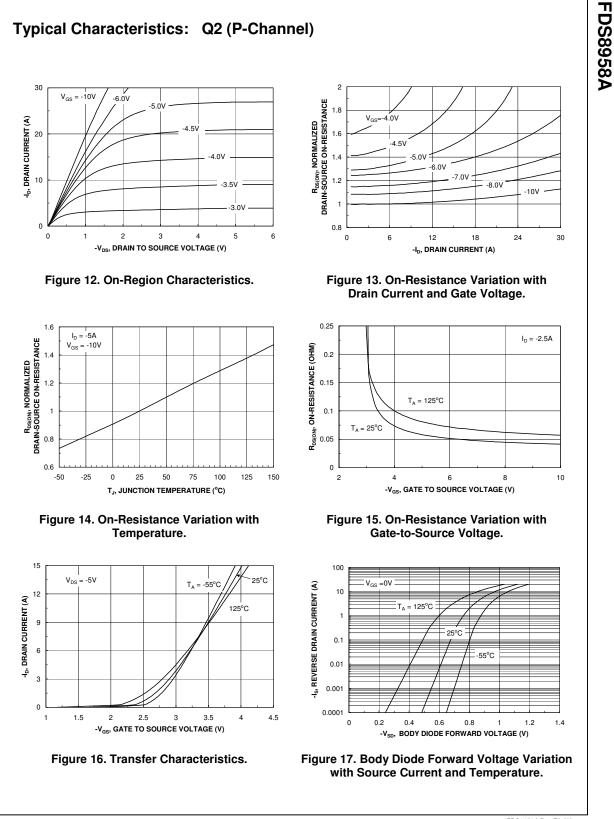
3. Starting TJ = 25 °C, L = 3mH, I_{AS} = 6A, V_{DD} = 30V, V_{GS} = 10V (Q1).

Starting TJ = 25 °C, L = 3mH, I_{AS} = 3A, V_{DD} = 30V, V_{GS} = 10V (Q2).

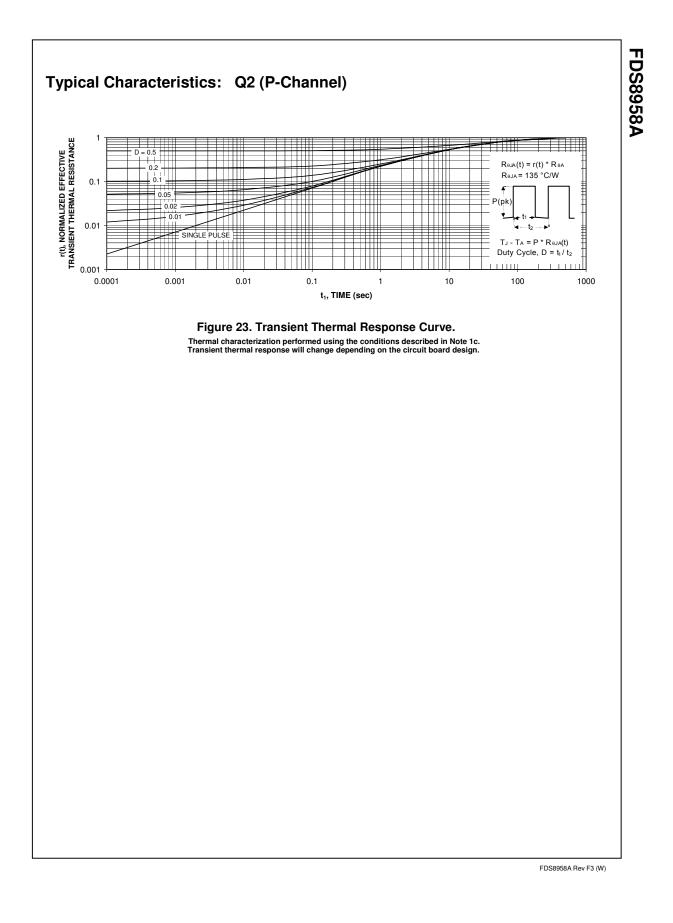


FDS8958A Rev F3 (W)





FDS8958A Rev F3 (W)





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